

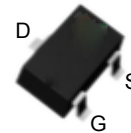
Features

- -60V/-0.13A,
 $R_{DS(ON)} = 2.2 \Omega$ (typ.) @ $V_{GS} = -10V$
 $R_{DS(ON)} = 2.5 \Omega$ (typ.) @ $V_{GS} = -4.5V$
- 100% UIS+ R_g Tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)
- ESD Protected

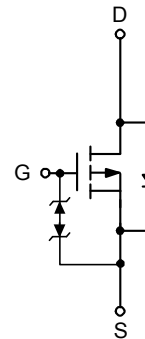
Applications

- Power Management in Notebook Computer, Portable Equipment and Battery Powered Systems.

Pin Description



Top View of SOT-23



P-Channel MOSFET

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter		Rating	Unit
V_{DS}	Drain-Source Voltage		-60	V
V_{GS}	Gate-Source Voltage		± 20	
I_D^*	Continuous Drain Current	$T_A = 25^\circ\text{C}$	-0.13	A
		$T_A = 70^\circ\text{C}$	-0.052	
I_{DM}^*	Pulsed Drain Current	$T_A = 25^\circ\text{C}$	-0.39	
		$T_A = 70^\circ\text{C}$	-0.156	
I_S^*	Diode Continuous Forward Current		-0.13	
T_J	Maximum Junction Temperature		150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55 to 150	
P_D^*	Maximum Power Dissipation	$T_A = 25^\circ\text{C}$	0.225	W
		$T_A = 70^\circ\text{C}$	0.09	
$R_{\theta JA}^*$	Thermal Resistance-Junction to Ambient	$t \leq 10\text{s}$	90	$^\circ\text{C/W}$
		Steady state	125	

Note * : Surface Mounted on 1in^2 pad area, $t \leq 10\text{sec}$.

Electrical Characteristics (T_A = 25°C unless otherwise noted)

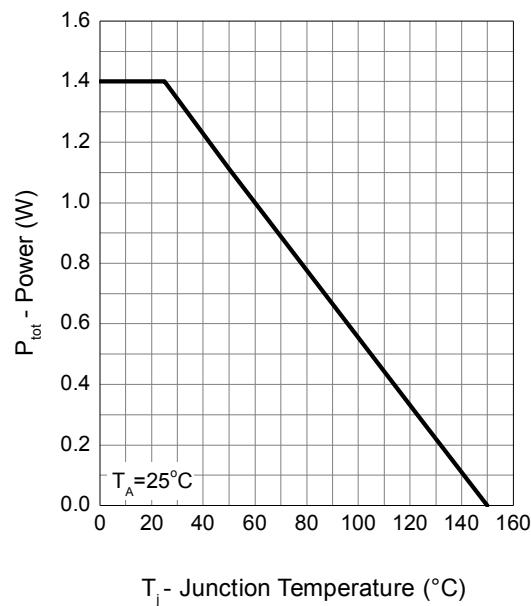
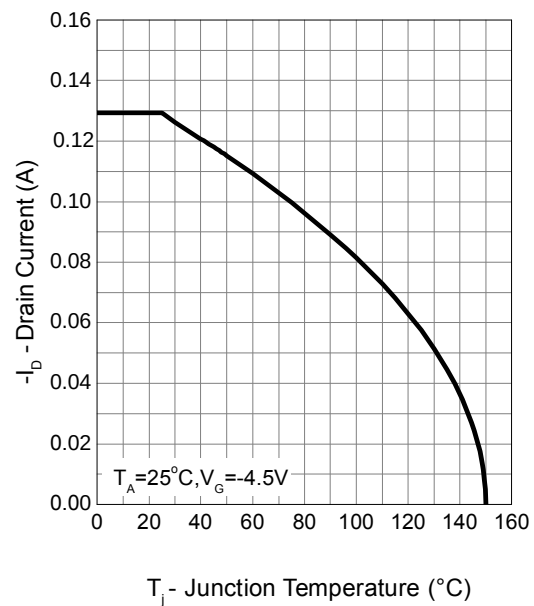
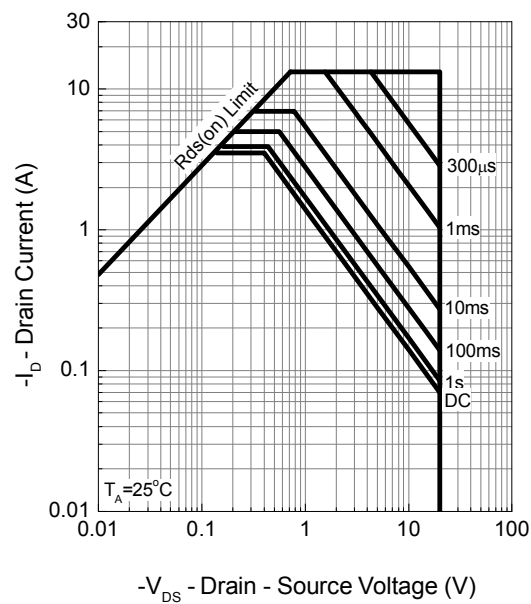
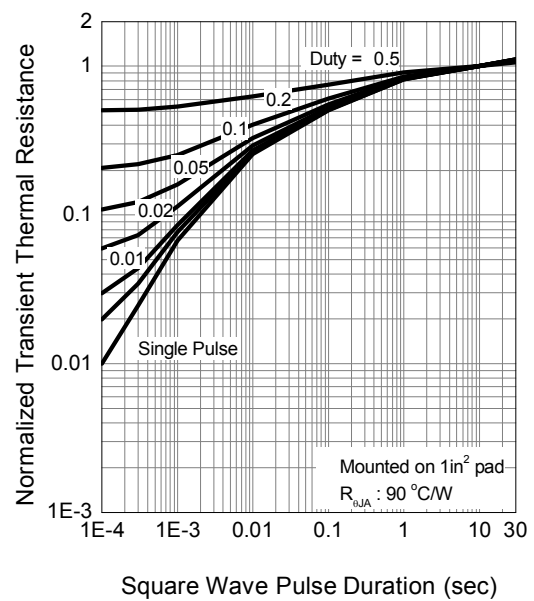
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =-250μA	-60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-48V, V _{GS} =0V T _J =85°C	-	-	-1 -30	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =-250μA	-0.8	-1.5	-2.5	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±10	uA
R _{DS(ON)} ^a	Drain-Source On-State Resistance	V _{GS} =-10V, I _{DS} =-0.5A V _{GS} =-4.5V, I _{DS} =-0.2A	- -	2.2 2.5	3.2 3.5	Ω
V _{SD} ^a	Diode Forward Voltage	I _{SD} =-1A, V _{GS} =0V	-	-0.7	-1	V
Dynamic Characteristics ^b						
R _G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	-	10.7	-	Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =-5V, Frequency=1.0MHz	-	30	-	pF
C _{oss}	Output Capacitance		-	10	-	
C _{rss}	Reverse Transfer Capacitance		-	5	-	
t _{d(ON)}	Turn-on Delay Time	V _{DD} =-10V, R _L =10Ω, I _{DS} =-1A, V _{GEN} =-4.5V, R _G =6Ω	-	2.8	-	ns
t _r	Turn-on Rise Time		-	1.2	-	
t _{d(OFF)}	Turn-off Delay Time		-	16	-	
t _f	Turn-off Fall Time		-	8	-	
t _{rr}	Reverse Recovery Time	I _{SD} =-3.3A, dI _{SD} /dt =100A/μs	-	16	-	nC
Q _{rr}	Reverse Recovery Charge		-	6	-	
Gate Charge Characteristics ^b						
Q _g	Total Gate Charge	V _{DS} =-10V, V _{GS} =-4.5V, I _{DS} =-3.3A	-	4.6	-	nC
Q _{gs}	Gate-Source Charge		-	0.7	-	
Q _{gd}	Gate-Drain Charge		-	1.8	-	

Note a : Pulse test; pulse width≤300μs, duty cycle≤2%.

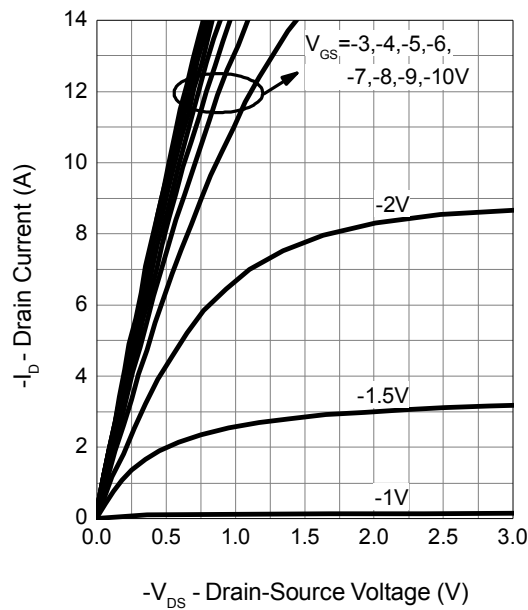
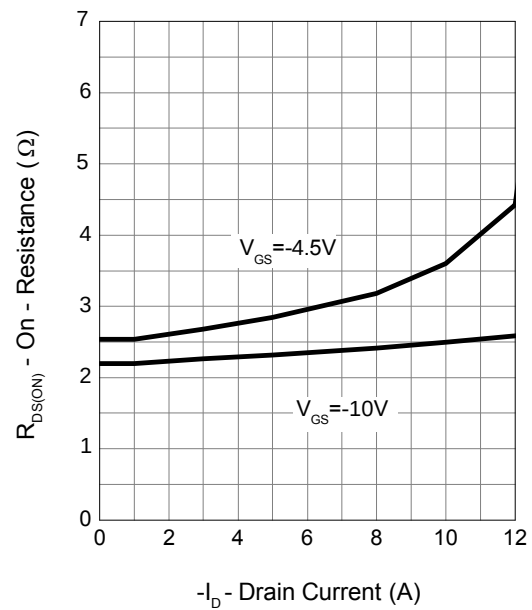
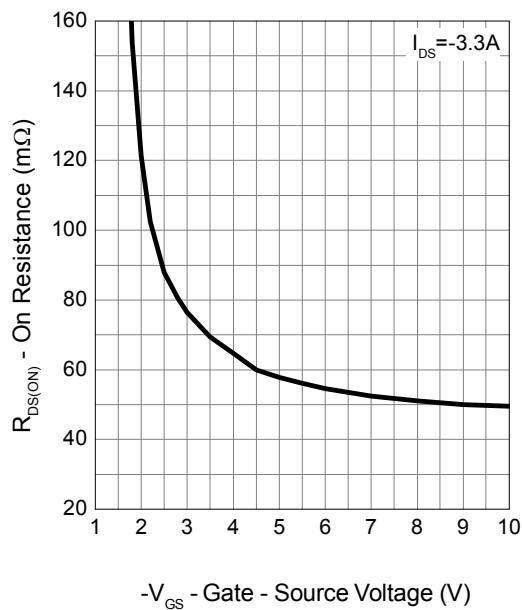
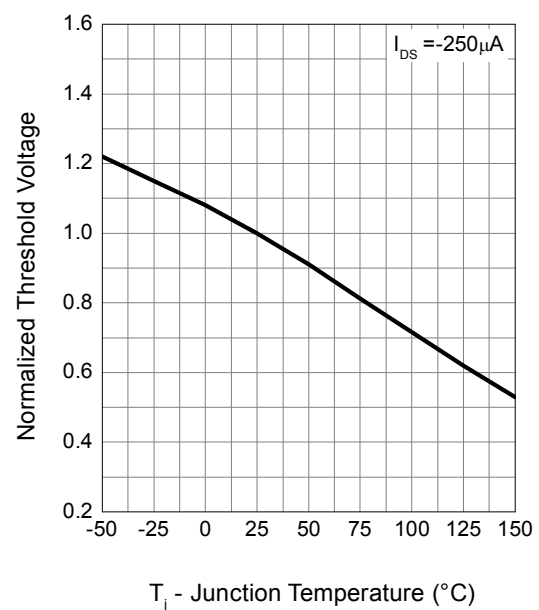
Note b : Guaranteed by design, not subject to production testing.

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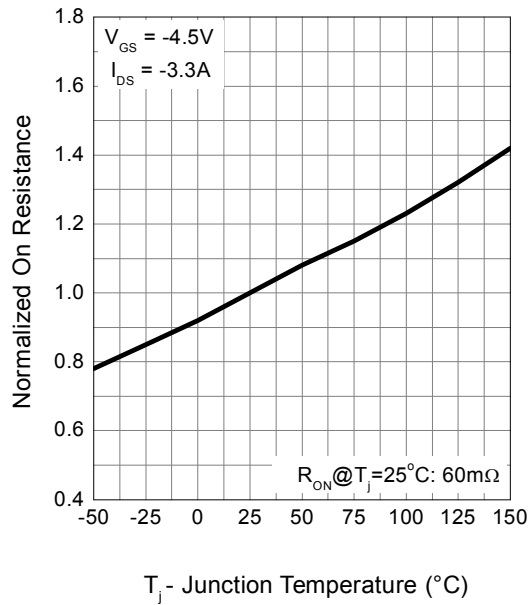
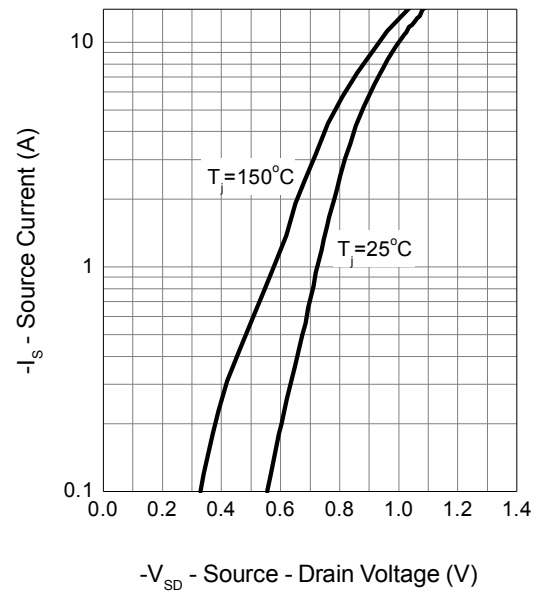
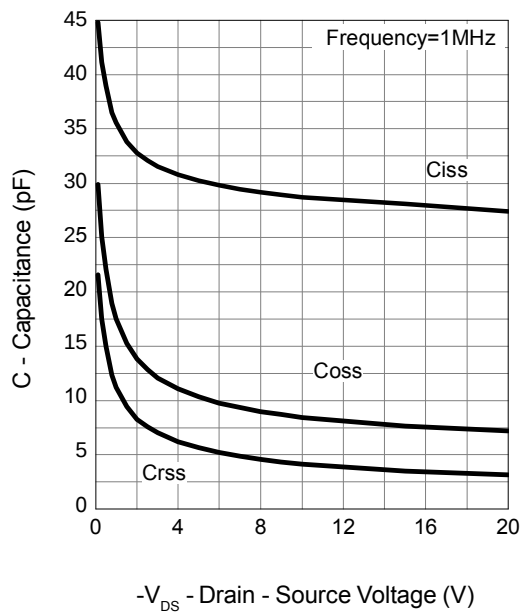
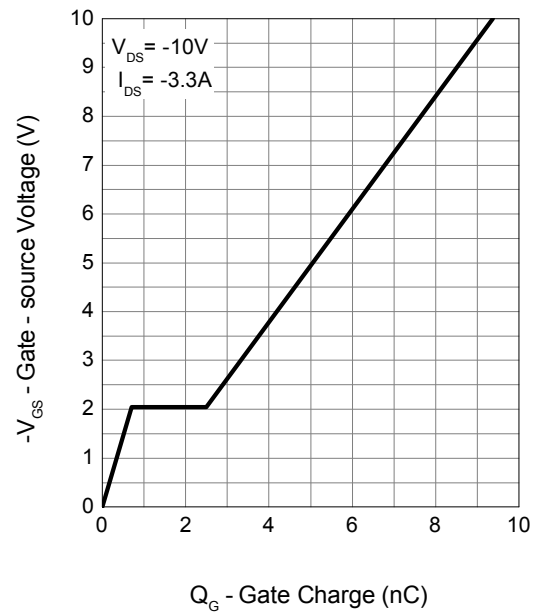
Typical Operating Characteristics

Power Dissipation

Drain Current

Safe Operation Area

Thermal Transient Impedance


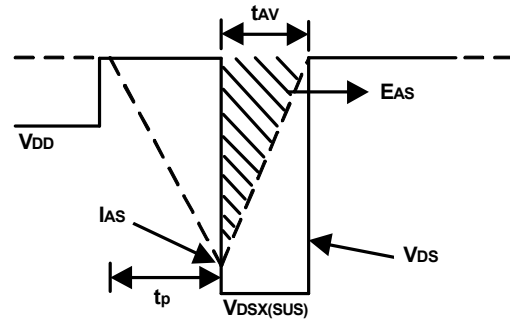
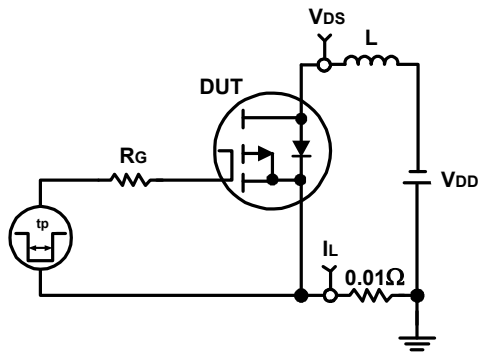
Typical Operating Characteristics (Cont.)

Output Characteristics

Drain-Source On Resistance

Gate-Source On Resistance

Gate Threshold Voltage


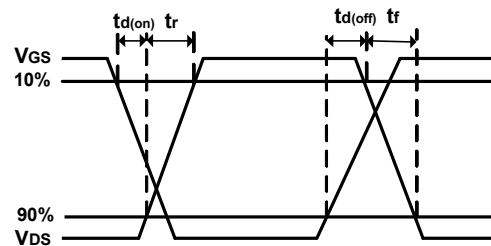
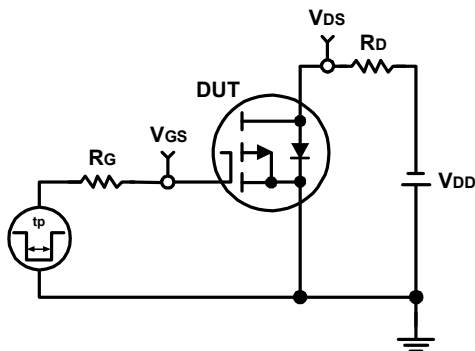
Typical Operating Characteristics (Cont.)

Drain-Source On Resistance

Source-Drain Diode Forward

Capacitance

Gate Charge


Avalanche Test Circuit and Waveforms

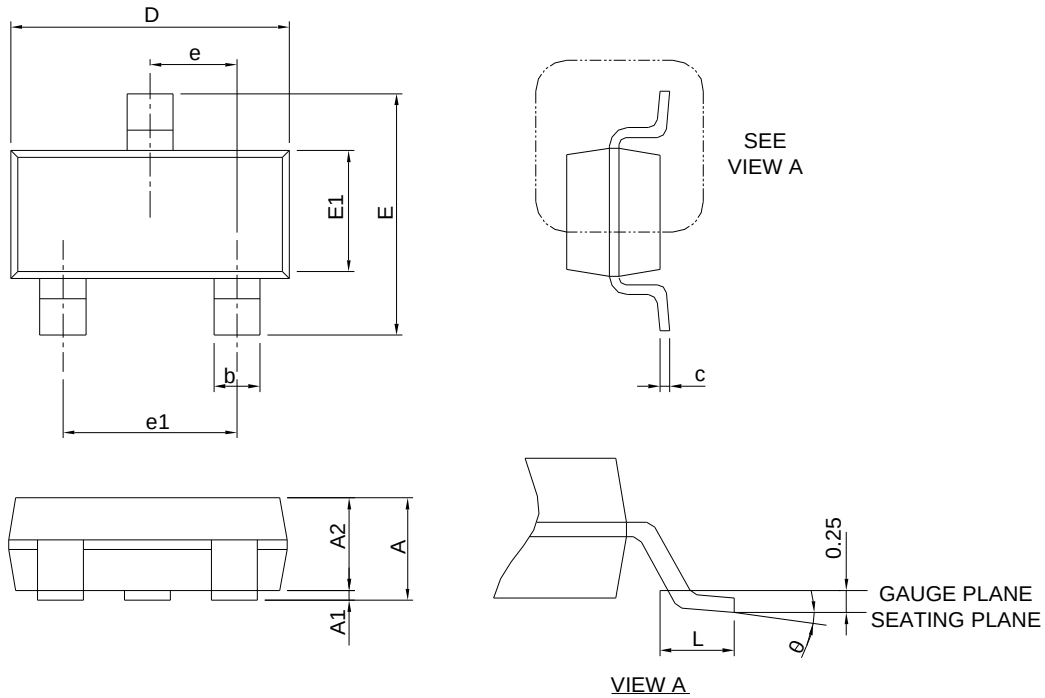


Switching Time Test Circuit and Waveforms



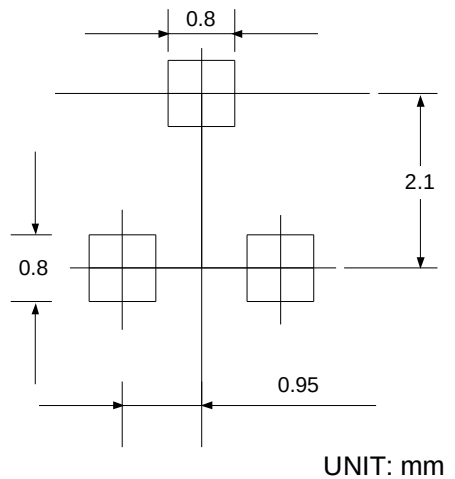
Package Information

SOT-23



SYMBOL	SOT-23			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	-	1.20	-	0.047
A1	0.00	0.10	0.000	0.004
A2	0.90	1.10	0.035	0.043
b	0.30	0.50	0.012	0.020
c	0.08	0.22	0.003	0.009
D	2.70	3.10	0.106	0.122
E	2.20	2.60	0.086	0.102
E1	1.20	1.40	0.047	0.055
e	0.95 BSC		0.037 BSC	
e1	1.90 BSC		0.075 BSC	
L	0.30	0.60	0.012	0.024
θ	0 °	8 °	0 °	8 °

RECOMMENDED LAND PATTERN



Note : Dimension D and E1 do not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.